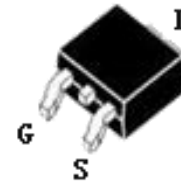
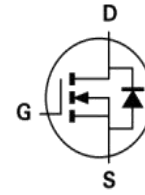


### MAIN CHARACTERISTICS

$I_D$	60A
$V_{DSS}$	40V
$R_{DS(ON)-typ}$ (@ $V_{GS}=10V$ )	8m $\Omega$



TO-252

### FEATURES

- Advanced Trench Technology
- Provide Excellent RDS(ON) and Low Gate Charge
- Lead free product is acquired

### APPLICATIONS

- Load Switch
- PWM Application
- Power management

### MECHANICAL DATA

- Case: Molded plastic
- Mounting Position: Any
- Molded Plastic: UL Flammability Classification Rating 94V-0
- Lead free in compliance with EU RoHS 2011/65/EU directive
- Solder bath temperature 275°C maximum, 10s per JESD 22-B106

### Product specification classification

Part Number	Package	Mode Name	Pack
LT60N04AD	TO-252	LT60N04AD	Tape

### Maximum Ratings at Tc=25°C unless otherwise specified

Characteristics	Symbol	Value	Unit
Drain-Source Voltage	$V_{DS}$	40	V
Gate-Source Voltage	$V_{GS}$	±20	V
Continue Drain Current	$I_D$	60	A
Pulsed Drain Current (Note1)	$I_{DM}$	240	A
Power Dissipation	$P_D$	35	W
Single Pulse Avalanche Energy (Note5)	$E_{AS}$	48	mJ
Operating Temperature Range	$T_J$	150	°C
Storage Temperature Range	$T_{STG}$	-55 to +150	°C
Thermal Resistance, Junction to Case(Note 2)	$R_{\theta JC}$	3.6	°C/W
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	37	°C/W

### Electrical Characteristics at Tc=25°C unless otherwise specified

Characteristics	Test Condition	Symbol	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	$V_{GS} = 0 V, I_D = 250 \mu A$	$BV_{DSS}$	40	-	-	V
Drain-Source Leakage Current	$V_{DS} = 40V, V_{GS} = 0 V$	$I_{DSS}$	-	-	1	μA
Gate Leakage Current	$V_{GS} = \pm 20 V, V_{DS} = 0 V$	$I_{GSS}$	-	-	±100	nA
Gate-Source Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250 \mu A$	$V_{GS(th)}$	1	-	2.5	V
Drain-Source On-State Resistance (Note)	$V_{GS} = 10 V, I_D = 30 A$	$R_{DS(on)}$	-	8	10	mΩ
	$V_{GS} = 4.5 V, I_D = 20 A$	$R_{DS(on)}$	-	10	13	mΩ
Input Capacitance	$V_{GS} = 0 V, V_{DS} = 20 V, f = 1 MHz$	$C_{iss}$	-	1910	-	pF
Output Capacitance		$C_{oss}$	-	130	-	pF
Reverse Transfer Capacitance		$C_{rss}$	-	105	-	pF
Turn-on Delay Time	$V_{DS}=20V, I_D=20A, V_{GS}=10V, R_G=3\Omega$	$t_{d(ON)}$	-	8	-	ns
Rise Time		$t_r$	-	28	-	ns
Turn-Off Delay Time		$t_{d(OFF)}$	-	36	-	ns
Fall Time		$t_f$	-	6	-	ns
Total Gate Charge	$V_{DS}=20V, I_D=20A, V_{GS}=10V$	$Q_G$	-	37	-	nC
Gate to Source Charge		$Q_{GS}$	-	8	-	nC
Gate to Drain Charge		$Q_{GD}$	-	7	-	nC

### Source-Drain Diode Characteristics at Ta=25°C unless otherwise specified

Characteristics	Test Condition	Symbol	Min.	Typ.	Max.	Unit
Maximun Body-Diode Continuous Current (Note 2)		$I_S$	-	-	60	A
Maximun Body-Diode Pulsed Current		$I_{SM}$	-	-	240	A
Drain-Source Diode Forward Voltage (Note 3)	$I_{SD} = 30A$	$V_{SD}$	-	-	1.2	V
Reverse Recovery Time	$I_S = I_F, I_{SD}=20A, V_{GS} = 0 V,$	$t_{rr}$	-	10	-	ns
Reverse Recovery Charge	$di/dt = 100 A/\mu s$ (Note3)	$Q_{rr}$	-	5	-	μC

Note2:Pulse test: 300 μs pulse width, 2 % duty cycle

### RATINGS AND CHARACTERISTIC CURVES

Figure 1: Output Characteristics

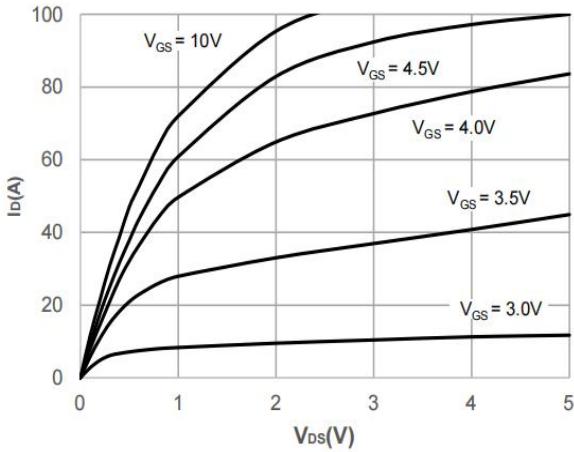


Figure 2: Typical Transfer Characteristics

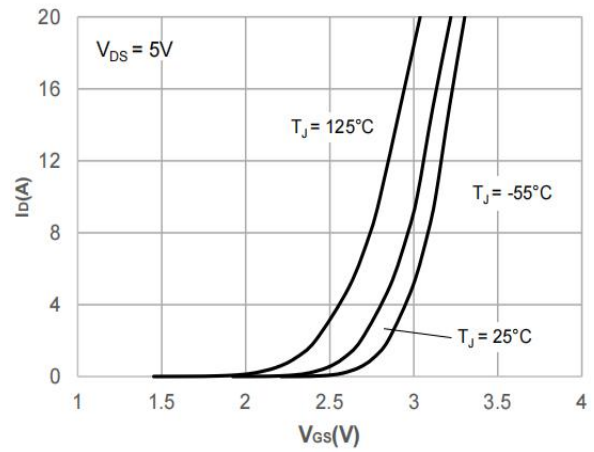


Figure 3: On-resistance vs. Drain Current

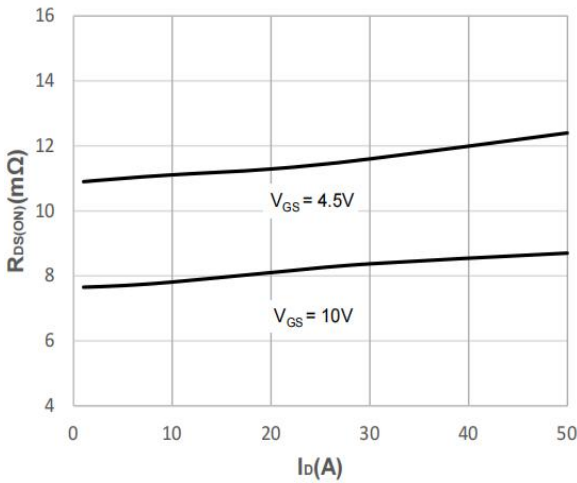


Figure 4: Body Diode Characteristics

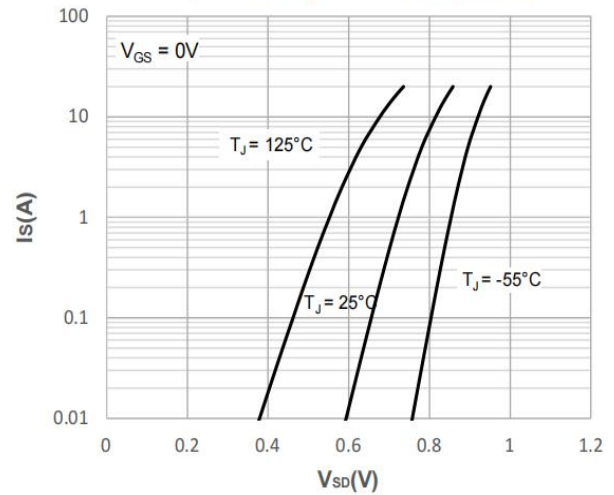


Figure 5: Gate Charge Characteristics

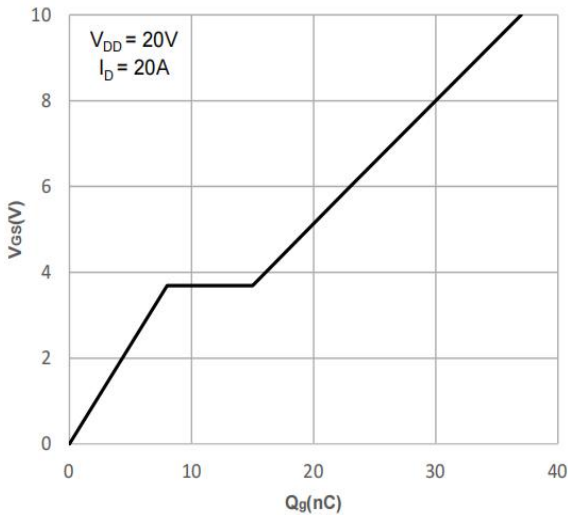
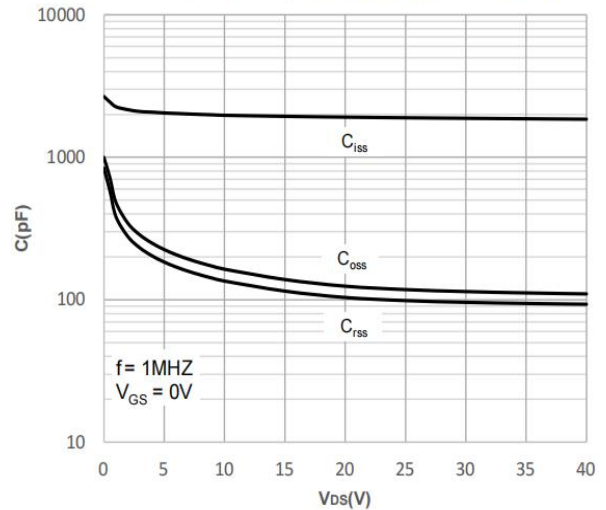


Figure 6: Capacitance Characteristics



### RATINGS AND CHARACTERISTIC CURVES

Figure 7: Normalized Breakdown voltage vs. Junction Temperature

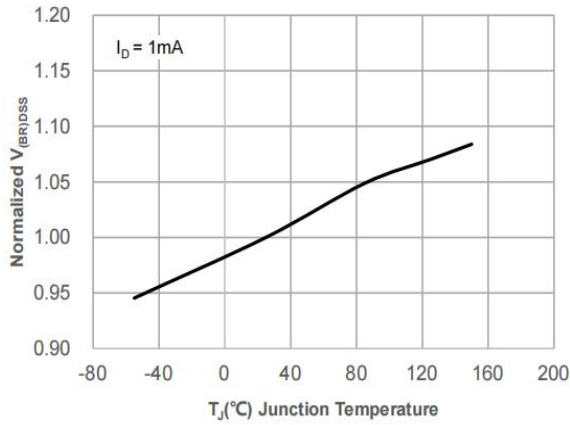


Figure 8: Normalized on Resistance vs. Junction Temperature

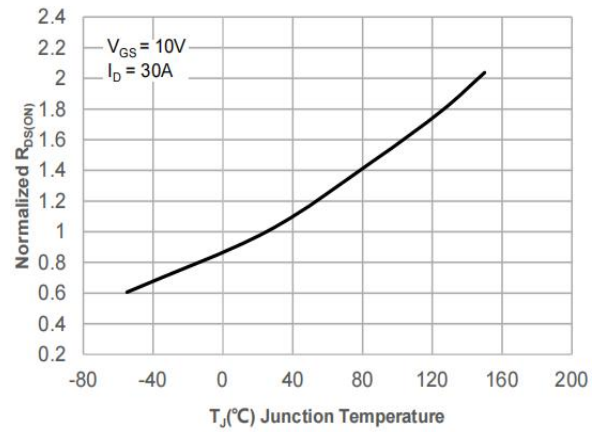


Figure 9: Maximum Safe Operating Area

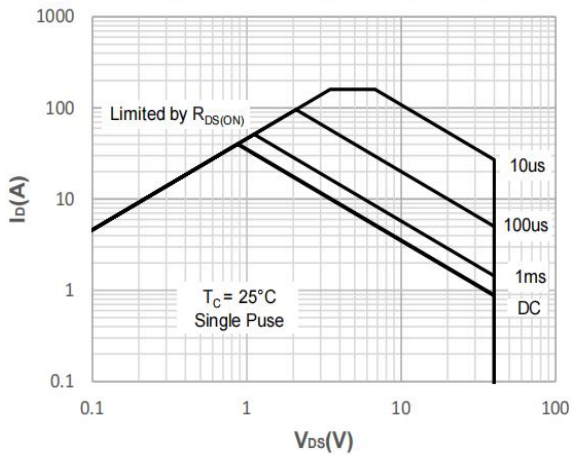


Figure 10: Maximum Continuous Driant Current vs. Case Temperature

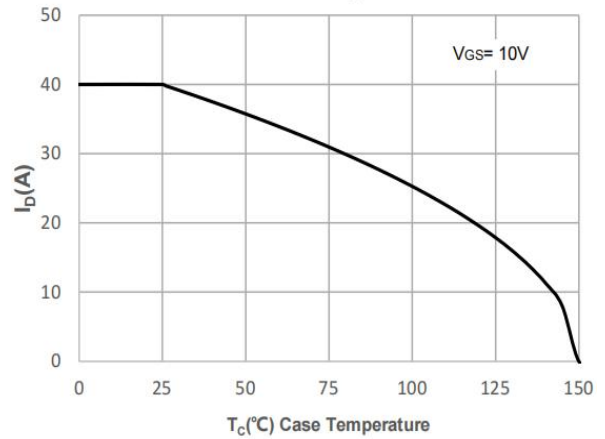


Figure 11: Normalized Maximum Transient Thermal Impedance

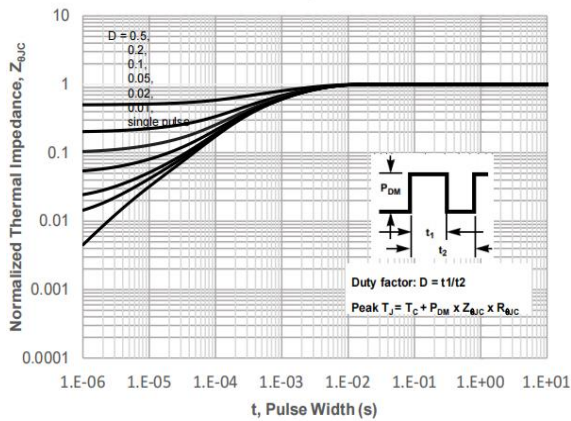
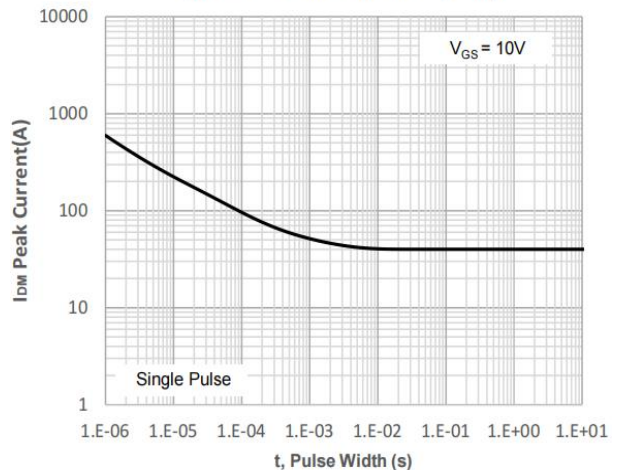
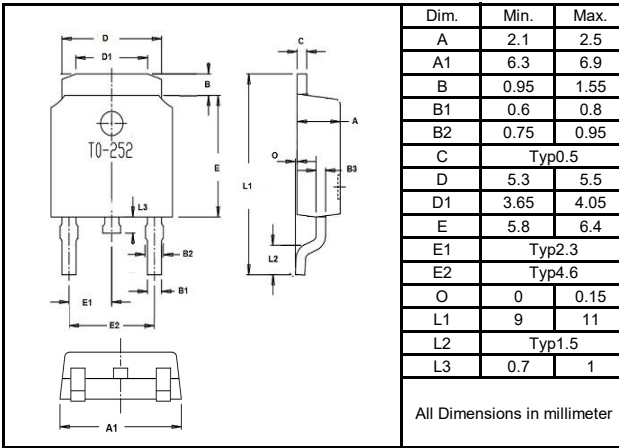


Figure 12: Peak Current Capacity

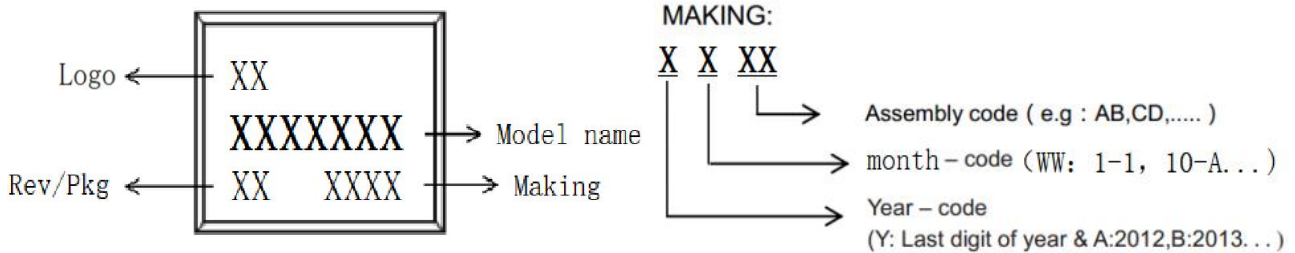


### Package Outline Dimensions millimeters

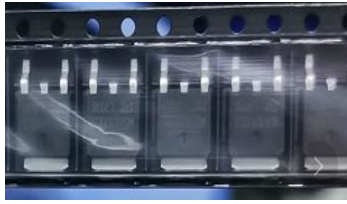


TO-252



### Marking on the body



### packing instruction

PKG	最小包装	内盒	外箱
TO-252			
	2500pcs/盘	5000pcs/盒	25000pcs/箱

### Notice

All product, product specifications and data are subject to change without notice to improve. The right to explain is owned by LINGXL company.

Confirm that operation temperature is within the specified range described in the product specification. Avoid applying power exceeding power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.

LINGXUN electronics shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in